

TIS/MADRID ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.1

MADRID ID: MD236667

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNS THE ENTIRE INTEREST AND THE GOODWILL
CONVEYING PARTY DATA	
Name	Execution Date
Huawei Technologies Co., Ltd.	04/26/2021
RECEIVING PARTY DATA	
Name:	Honor Device Co., Ltd.
Address:	Suite 3401, Unit A, Building 6, Shum Yip Sky Park, No. 8089, Hongli West Road, Xiangmihu Street, Futian District, Shenzhen 518040 Guangdong
Country:	CN
Entity Type:	Limited company
Entity Country:	The People's Republic of China
PROPERTY NUMBERS Total: 1	
Property Type	Number
Serial Number:	79252619
CORRESPONDENCE DATA	
Correspondent Name:	Honor Device Co., Ltd.
Address:	Suite 3401, Unit A, Building 6, Shum Yip Sky Park, No. 8089, Hongli West Road, Xiangmihu Street, Futian District, Shenzhen 518040 Guangdong
Country:	CN

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